

TECHNICAL DATA DATA SHEET 830, REV. –

HERMETIC POWER SCHOTTKY RECTIFIER

200°C Maximum Operation Temperature Very Low Forward Voltage Drop

Applications:

• Switching Power Supply • Converters • Free-Wheeling Diodes • Polarity Protection Diode

Features:

- Soft Reverse Recovery at Low and High Temperature
- Very Low Forward Voltage Drop
- Low Reverse Leakage Current
- Low Power Loss, High Efficiency
- High Surge Capacity
- Guard Ring for Enhanced Durability and Long Term Reliability
- Guaranteed Reverse Avalanche Characteristics

MAXIMUM RATINGS

ALL RATINGS ARE @ T_C = 25 °C UNLESS OTHERWISE SPECIFIED.

RATING	SYMBOL	MAX.	UNITS
PEAK INVERSE VOLTAGE	PIV	200	Volts
MAXIMUM DC OUTPUT CURRENT (With Cathode Maintained @ $T_C=100$ $^{\circ}$ C) (per leg)	lo	15	Amps
MAXIMUM NONREPETITIVE FORWARD SURGE CURRENT (t=8.3ms, Sine)	I _{FSM}	280	Amps
MAXIMUM THERMAL RESISTANCE (Junction to Mounting Surface, Cathode) (per leg)	$R_{ ext{ hetaJC}}$	0.40	°C/W
MAXIMUM OPERATING AND STORAGE TEMPERATURE RANGE	Top/Tstg	-65 to + 200	°C
MAXIMUM STORAGE TEMPERATURE RANGE	Top/Tstg	-65 to + 175	°C

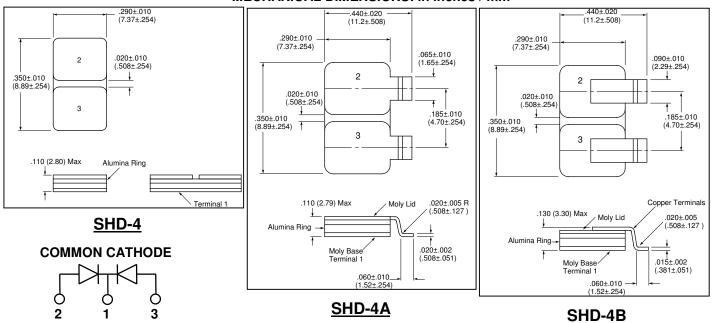
ELECTRICAL CHARACTERISTICS

CHARACTERISTIC				
MAXIMUM FORWARD VOLTAGE DROP, Pulsed (I _f	_f = 15 Amps)			
	T _J = 25 °C T _J = 125 °C	V_{f}	0.92 0.76	Volts
MAXIMUM REVERSE CURRENT (I, @ 200V PIV)				
· ·	T _J = 25 °C T _J = 125 °C	l _r	0.35 8.0	mA
MAXIMUM JUNCTION CAPACITANCE	$(V_r = 5V)$	C_{T}	300	pF

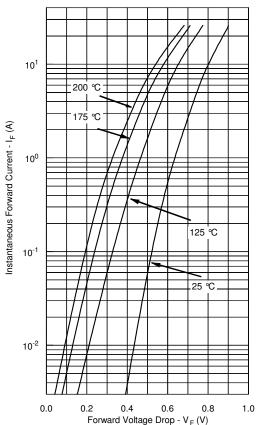
SENSITRON

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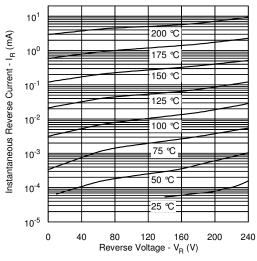
MECHANICAL DIMENSIONS: in inches / mm

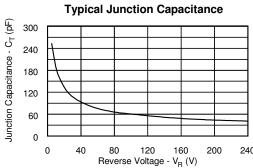


Typical Forward Characteristics



Typical Reverse Characteristics







TECHNICAL DATA

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